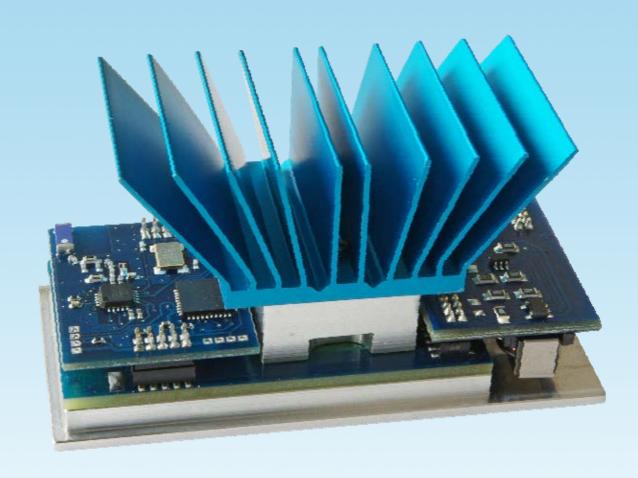
TE-Power NODE

Self-Sufficient
Wireless Sensor System
Thermoharvesting Explorer



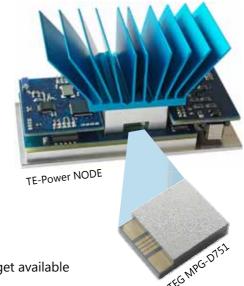


Self-powered, Wireless Sensor Node & Thermoharvesting Explorer

1. General Description

Micropelt's energy harvesting technology is capable of replacing a battery-based energy supply with infinite thermoharvesting that feeds on local excess heat. Benefits of this type of power supply are: High reliability and low environmental impact through the absence of battery chemistry, virtually service-free operation, true wireless installation.

Gross ΔT [°C] (ambient to heat source)	mAh per year	Equivalent number of AA type batteries		
35	3,628	2-4		
75	21,207	11-20		



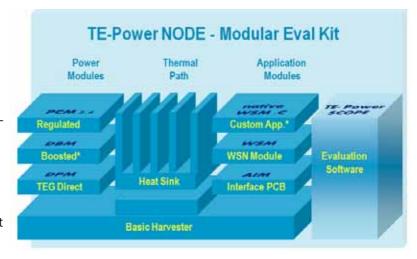
Micropelt offers various evaluation kits to help determine the power budget available through thermoharvesting:

Evaluation Kit Overview		Plug-On Modules *			Other *			
Evaluation Kit Overview	Description	Direct Power Module DPM	DC Boost- er Module DBM	Power Conditioning Module PCM	Application Interface Module AIM	Wireless Sensor Module WSM	USB Radio Receiver	TE-Power SCOPE
TE-Power NODE (this document)	Wireless 2,4 GHZ temp. sensing system with power management	√		√	√	√	√	√
TE-Power PLUS	DC-boosted variable output voltage (1.6 - 5.0 V)	√	√					
TE-Power ONE	Direct TEG output power with temp. sensor	√						

^{*} individual modules available on request

The TE-Power NODE kit consists of an aluminum heat spreader (63 x 30mm, 2.48" x 1.18") that carries one MPG-D751 thermoelectric generator (TEG). The DC Booster Module converts the thermo-voltage from the generator to 2.4 V, buffered by a 100 μ F reservoir capacitor. This in turn supplies the Wireless Sensor Module which is based on Texas Instrument's (TI) ultra-low power technology.

A temperature difference as little as 10 °C of 'gross' ΔT between target surface and ambient air is sufficient for the TE-Power NODE to transmit 13 bytes worth of information once



every second. A computer reads the data through a USB radio receiver. On the PC, the TE-Power SCOPE application software provides a convenient user interface which clearly informs about harvesting results. The software displays current temperatures and voltages. Beyond this it is capable of simulating the charge and subsequent discharge of an energy reservoir.

1.1 Features & Benefits of the TE-Power NODE Kit

- High voltage micro-thermogenerator MPG-D751 with best thermo-electric efficiency starting from low DT
- Modular layout for flexible exploration of all harvesting dimensions and remote system aspects
- Wireless module with additional digital sensor interfaces and re-programming option
- Wireless operation facilitates fast and flexible temperature exploration and power budgeting
- TE-Power SCOPE evaluation software for quick and easy assessment and simulation
- Optional add-on modules facilitate test-driving of target application



1.2 Applications

- Wireless Sensor Networks (WSN)
- Industrial Process Monitoring
- Condition Monitoring
- Intelligent Data Loggers
- Automated Meter Reading (AMR)
- Building Automation and HVAC
- Energy Monitoring and Control
- Triggering & Powerless Switching

















 $Copyright\ 2010@ gizmo |\ bravajulia |\ marafona |\ yanj |\ jolin |\ yobidaba\ images\ from\ www.bigstockphotos.com\ |\ 2007/2008@ www.aboutpixel.com\ |\ 2009@ www.istockphoto.com\ |\ 2007/2008@ www.aboutpixel.com\ |\ 2009@ www.aboutpixel.com\ |\$



Self-powered, Wireless Sensor Node & Thermoharvesting Explorer

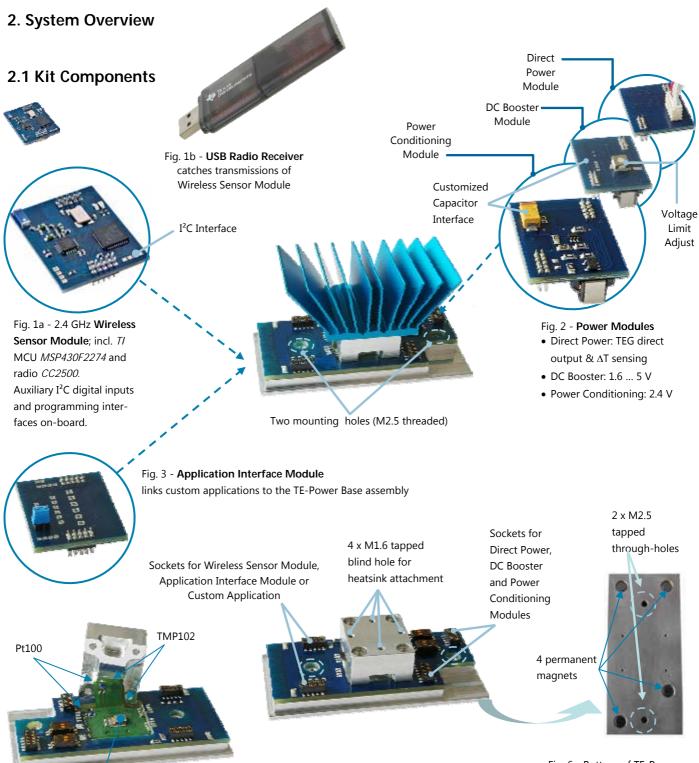


Fig. 4 - MPG-D751 thermoelectric generator chip mounted on Al heat spreader along with digital TMP102 and analog Pt100 temperature sensors.

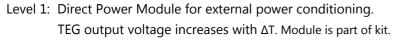
Fig. 5 - **TE-Power Base** assembly with heatsink adaptor and routing PCB. Module interfaces and TEG polarity-inverting DIP switches.

Fig. 6 - Bottom of TE-Power Base assembly with permanent magnets and tapped mounting holes for easy attachment to surfaces and adaptors.

Self-powered, Wireless Sensor Node & Thermoharvesting Explorer

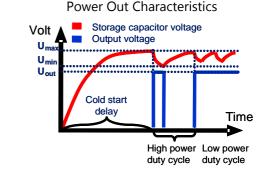
2.2 Power Output & Conditioning

Energy harvesting using a thermoelectric generator (TEG) is ideal for low duty cycle applications. The raw TEG output is converted to a constant voltage which directly supplies the system's sleep power consumption. Surplus power is stored in a capacitor or rechargeable battery for use during the load's active cycle. The following power supply modules are compatible with the TE-Power NODE:



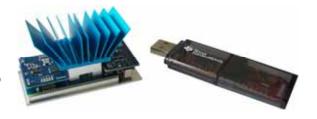
Level 2: Voltage-adjustable (1.6 .. 5 V) DC Booster Module for external power conditioning. Not part of kit.

Level 3: Voltage-regulated (2.4 V) Power Conditioning Module for direct supply of application. Fitted by default.



2.3 Wireless Sensor Module

The pluggable Wireless Sensor Module is built around TI's MSP430 ultra-low power microcontroller (MCU) and a TI CC2500 2.4 GHz transceiver chip. Two digital temperature sensors are connected to the MCU's $\rm I^2C$ interface. They are mounted close to the thermogenerator's hot and cold side, sensing the so-called "net ΔT " across the TEG chip. Two more $\rm I^2C$ -compatible sensors



may be connected. A TI <u>ez430-RF2500</u> USB receiver links to a computer running the TE-Power SCOPE graphical user interface software. Data transmission is governed by TI's 'Simplicity' protocol stack, set up as unidirectional star network. Unique transmitter address for each TE-Power NODE ensure proper data allocation. A transmission time <1 ms avoids data collision in multi-NODE environments.

2.4 TE-Power SCOPE Graphical User Interface

TE-Power SCOPE receives and presents the samples transmitted by the TE-Power NODE on a one-per-second basis:

- Temperature, hot side of thermogenerator
- Temperature, cold side of thermogenerator
- Supply voltage before regulation

Several other values are derived from the above measurements:

- Effective temperature difference (net ΔT)
- Heat flux through harvester
- Gross harvesting power
- Net harvesting power
- Capacitor/battery charge current
- Charge progress indicator
- Charge level
- Energy balance

When load parameters* of a target application are specified, TE-Power SCOPE calculates average power and net energy balance.

* sleep / active power consumption, duty cycle terms





3. Electrical Parameters

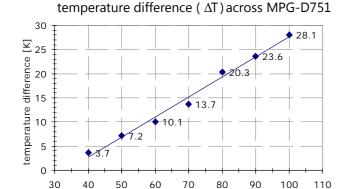
Test Conditions:

Natural convection, vertically mounted (Fig. B1, page 7), no airflow (lab environment)

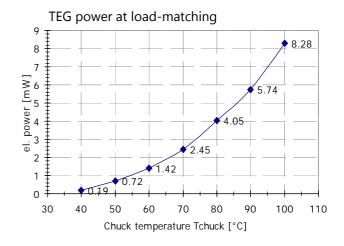
typical thermoelectric characteristics of the assembly before DC boosting

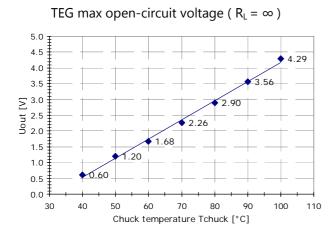
Tchuck* [°C]	Net ΔT [°C] across TEG	TEG open circuit voltage [V]	TEG power at load matching [mW]
40	3,7	0,6	0,2
50	7,2	1,2	0,7
60	10,1	1,7	1,4
70	13,7	2,3	2,5
80	20,3	2,9	4,1
90	23,6	3,6	5,7
100	28,1	4,3	8,3

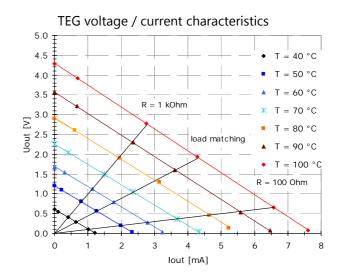
^{*} Tchuck = temperature of heat source



Chuck temperature Tchuck [°C]







4. Application of the TE-Power NODE

4.1 Attaching the Assembly to a Harvesting Target

Attachment of a thermoharvester to its target heat source is a critical factor in any application. The TE-Power NODE helps to explore the effects of mounting pressure, surface flatness / roughness and various thermal interfaces materials on the harvesting result. The base of the assembly attaches to the target either through magnetic force or through 2 tapped mounting holes (M2.6).

4.2 Heatsink Positioning and Orientation

Both positioning and orientation of the TE-Power NODE are of major importance for the power yield, particularly when the power density of the heat source is low. The alignment of the heatsink fins relative to the heat source and the direction of natural convection deserves special attention. To help optimize this, the heatsink adaptor has been designed so that the heatsink can be removed and then re-attached perpendicular to its default orientation. Note that it is thermally inefficient to place the TE-Power NODE horizontally on top of a heat source (figure A) where hot air warms the heat-sink. This reduces the effective temperature difference across the thermogenerator thus lowering the thermovoltage and consequently the TEG's power output. A forced air flow over the heatsink instead maximizes power, regardless of position and orientation.

4.3 Radiation Suppression

Hot surfaces radiate in the infrared spectrum. This can cause the TE-Power NODE's heatsink to heat up, diminishing effective ΔT and thus the power output of the device. In such cases it may be helpful to cover the hot surface near the TE-Power NODE such that radiation is inhibited. Alternatively, a block of thermally conductive material may be used to increase the distance between radiating surface and heatsink, thereby improving natural convection.



Figure A: Inferior positioning

TE-Power NODE mounted on top of the heat source, surrounded by a bubble of warm air warming the heatsink. This arrangement yields low ΔT and low power output.

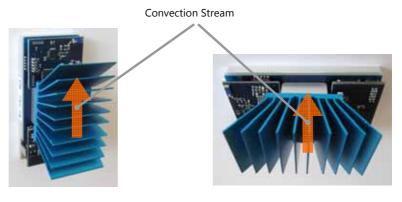


Figure B1: Preferred positioning

TE-Power NODE mounted on a vertical surface with the heatsink fins aligned horizontally. Results in acceptable performance

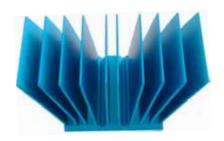
Figure B2: Ideal positioning

TE-Power NODE mounted on a vertical surface with the heatsink fins aligned vertically. This is best supporting natural convection and results in the highest possible ΔT and power output.

4.4 Thermal Path Optimization

The standard heatsink of the TE-Power NODE is a compromise between physical size and thermal performance. The heatsink is a stock part, selected for superior performance with lower temperature gradients. For high temperature gradients, the heatsink should be verified.

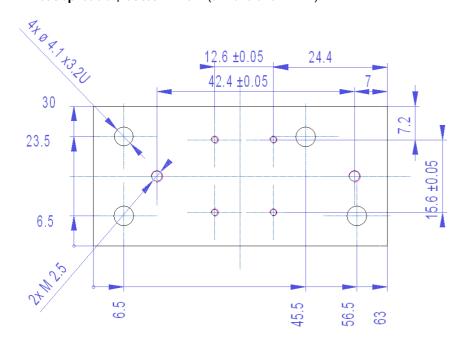
Different applications ask for different heatsink designs, so the TE-Power NODE features an aluminum adaptor for easy attachment of alternative heatsinks. This allows for thorough and comprehensive exploration of the thermal path under varying thermal conditions. A more suitable heatsink will, under otherwise identical conditions, stay cooler. Both the cold side temperature shown by the TE-Power SCOPE software and the power yield of the TEG will reflect this.



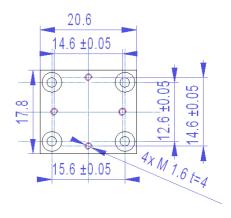
Finned heatsink for low heat flux under natural convection

5. Dimensions of Heat Spreader and Heatsink Adaptor

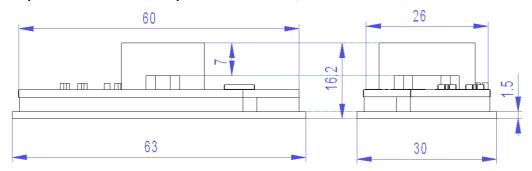
Heat spreader, bottom view (dimensions in mm)



Heatsink adaptor, top view (dimensions in mm)



Heatsink adaptor mounted on heat spreader, side view (dimensions in mm)



Self-powered, Wireless Sensor Node & Thermoharvesting Explorer

6. Technical Data

	Parameter	Value
General	Max. operating temperature	
	hot side	105°C
	ambient air	85°C
Thermal Path	Thermogenerator	MPG-D751
	Footprint	3.3 x 4.2 mm
	Thermovoltage	140 mV/K
	Thermal resistance	12.5 K/W
	Heatsink adaptor	
	Mounting face	20.6 x 17.8 mm
	Heatsink attachment	4x M1.6 x 4 mm tapped blind hole
	Heatsink (standard blue fin type)	ATS-50270P-C2-R0, Advanced Thermal Solutions Inc
	Thermal resistance	approx. 31 K/W under natural convection
	Mounting holes	2x 1.8 mm through hole
Power Modules	Power Conditioning Module	
i ower intoduces	Max. operating temperature	105°C
	Output voltage	2.4 V fixed, regulated
	Storage capacitor	100 μF
	Capacitor extension interface	Through hole for solder connection
	DC Booster Module	, and the second
	Max. operating temperature	105°C
	Output voltage	1.6 5 V adjustable, regulated
	Capacitor extension interface	Through hole for solder connection
	Direct Power Module	, and the second
	Max operating temperature	105°C
	Connector signals:	6 wires, open end
	TEG cold side temperature pins 1-2	Pt100 sensor
	TEG hot side temperature, pins 3-4	Pt100 sensor
	TEG voltage output, pins 5-6	ΔT x thermovoltage (140 mV/K)
Wireless Module	Wireless Sensor Module	
· · · · · · · · · · · · · · · · · · ·	Max. operating temperature	105°C
	System supply voltage	2.4 V DC
	Microcontroller	TI MSP 430-F2274
	Wireless device	TI CC2500
	Digital sensor interface	I ² C, 4 channels, thereof 2 unused
	Programming interface	TI ByWire
	Wireless USB receiver	TI EZ430-F2500
	Wireless protocol stack	Proprietary / TI Simplicity
	Topology	Unidirectional star network
	Payload	10 byte
	Active cycle (collect, compute, transmit)	2 ms
	Signal acquisition:	
	Temperature, hot side & cold side	2x TI TMP102 on I ² C
	2x user signal	2x I ² C (unused)
	System voltage	MSP430 internal
Custom Applications	Application Interface Module	
- Locality Applications	Supply voltage	2.4 V or 1.6 5 V, depending on power module
Dimensions	Base / heat spreader W x L	30 mm x 63 mm
Dimensions	Total height incl. standard heatsink	33.6 mm
	Height with heatsink adaptor only	16.2 mm
	Weight TE-Power NODE with 2 plug-on modules	49 g

Micropelt GmbH | Headquarters

Emmy-Noether-Str. 2 | 79110 Freiburg (Germany)

Phone: +49 (0)761–156 337-0 | Fax: +49 (0)761–156 337-21

Email: info@micropelt.com | www.micropelt.com Production | Blücher-Str. 26 | 06122 Halle (Germany)





7. Important Notices - Please read carefully.

1. Micropelt Products are prototypes

Micropelt supplies thermoelectric coolers and generators, as well as energy harvesting modules (hereinafter referred to as "Prototype Products"). The Prototype Products distributed by Micropelt to date are prototypes that have not yet been released to manufacturing and marketing for regular use by end-users. The Prototype Products are still being optimized and continuously tested. As such, the Prototype Products may not fully comply with design-, marketing-, and/or manufacturing-related protective considerations, including product safety and environmental measures typically found in end products that incorporate such semiconductor components or circuit boards.

In addition, the Products have not yet been fully tested for compliance with the limits of computing devices, neither pursuant to part 15 of FCC rules nor pursuant to any other national or international standards, which are designed to provide reasonable protection against radio frequency interference.

2. Use of Products restricted to demonstration, testing and evaluation

Micropelt's Prototype Products are intended exclusively for the use for demonstration, testing and evaluation purposes. The Prototype Products must not be used productively. In particular, the Prototype Products must not be used in any safety-critical applications, such as (but not limited to) life support systems, near explosion endangered sites, and/or any other performance critical systems.

The Prototype Products must only be handled by professionals in the field of electronics and engineering who are experienced in observing good engineering standards and practices.

3. User Guide

Please read the User Guide carefully prior to use.

4. Warnings and use instructions

- Using Micropelt's Prototype Products without care and in the wrong context is potentially dangerous and could result in injury or damage.
 - The Prototype Products are designed for use within closed rooms in conditions as apply for electronics such as computers; except when indicated expressively. Keep the Prototype Products away from open fire, water, chemicals, gases, explosives as well as from temperature conditions above 100 degrees centigrade, or as indicated in the datasheet of the product. When testing temperature settings at the limits given in the User Guide or datasheet for longer term, do not leave the Prototype Products alone but monitor their performance. Take special care to monitor closely whenever the Prototype Products are connected to other electrical items and/or electronics.
- The Prototype Products use wireless data transmission technology, therefore they receive and radiate radio frequency energy. They have not yet been fully tested for compliance with the limits of computing devices, neither pursuant to part 15 of FCC rules nor pursuant to any other national or international standards, which are designed to provide reasonable protection against radio frequency interference. Operation of the Prototype Products may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be necessary to correct this interference and prevent potential damage. Do take special care not to operate the Prototype Products near safety-critical applications or any other applications known to be affected by radio frequencies.
- If any of the Prototype Products elements are separated from the complete module and used independently, it is important to control each individual system's power supply to be within their acceptable voltage and/or amperage range. Exceeding the specified supply voltage and/or amperage range may cause unintended behavior and/or irreversible damage to the Prototype Products and/or connected applications. Please consult the Prototype Products' User Guide prior to connecting any load to the Prototype Products' output. Applying loads outside of the specified output range may result in unintended behavior and/or permanent damage to the Prototype Products. If there is uncertainty as to the supply or load specification, please contact a Micropelt engineer.
- During normal operation, some circuit components may have case temperatures greater than 70°C. The Prototype Products are designed to operate properly with certain components above 70°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the evaluation unit schematic located in the evaluation unit User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be as hot as to inflict the risk of burning skin when touched.
- Due to the open construction of the Prototype Products, it is the user's responsibility to take any and all appropriate precautions with regard to electrostatic discharge and any other prevention measures for safety.

5. User's Feedback

Micropelt welcomes the user's feedback on the results of any tests and evaluations of the Prototype Products. In particular, we appreciate experience information on use cases with indications of strengths and weaknesses of the Prototype Products, its robustness in operation and its long-term durability. Please, contact our Micropelt Application Engineering colleagues by email at engineering@micropelt.com.

Prototype Products, its robustness in operation and its long-term durability. Please, contact our Micropelt Application Engineering colleagues by email at engineering@micropelt.com.

Micropelt GmbH | Emmy-Noether-Str. 2 | 79110 Freiburg (Germany)

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Micropelt:

TE-POWER-NODE